



LED Display
Product Data Sheet
LTS-2806SKG-P

Spec No. :DS30-2010-0095
Effective Date: 01/15/2020
Revision: A

LITE-ON DCC

RELEASE

BNS-OD-FC001/A4

**LED DISPLAY
LTS-2806SKG-P**

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<u>Rev</u>	<u>Description</u>	<u>By</u>	<u>Date</u>
01	Preliminary Spec.	Eason Lin	02/09/2010
02	Correction Pin out	Eason Lin	03/24/2010
03	Correction Pin 1 Position and Pin out Definition	Eason Lin	09/15/2010
04	Change Reel Drawing	Eason Lin	11/10/2010
Above data for PD and Customer tracking only			
-	NPPR Received and Upload on System	Eason Lin	11/10/2010
A	Update Packing spec. in page 9	Reo Lin	01/10/2020

LED DISPLAY LTS-2806SKG-P

1. Description

The LTS-2806SKG-P is a 0.28 inch (7.0 mm) digit height single digit SMD display. This device utilizes AllnGaP green LED chips which are made from AllnGaP on a non-transparent GaAs. The display has gray face and white segments.

1.1 Features

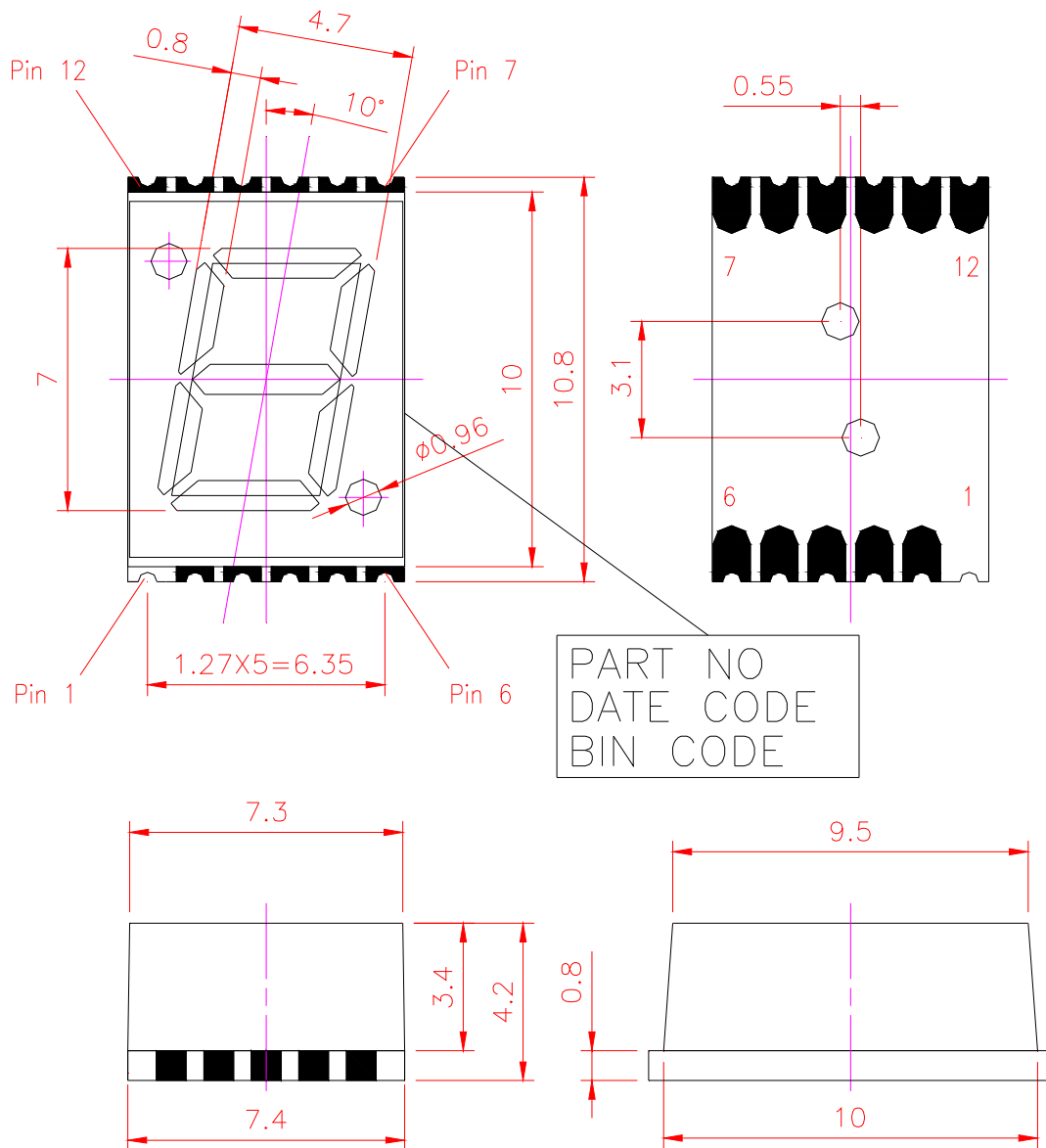
- 0.28 inch (7.0 mm) DIGIT HEIGHT
- CONTINUOUS UNIFORM SEGMENTS
- LOW POWER REQUIREMENT
- EXCELLENT CHARACTERS APPEARANCE
- HIGH BRIGHTNESS & HIGH CONTRAST
- WIDE VIEWING ANGLE
- SOLID STATE RELIABILITY
- CATEGORIZED FOR LUMINOUS INTENSITY.
- LEAD-FREE PACKAGE (ACCORDING TO ROHS)

1.2 Device

Part No	Description
AllnGaP Green	Common Anode
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2. Package Dimensions

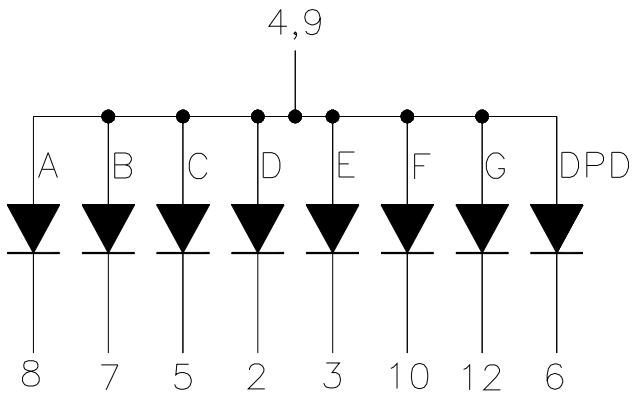
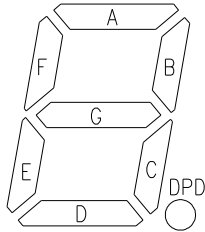


Notes :

1. All dimensions are in millimeters. Tolerances are ± 0.25 mm (0.01") unless otherwise noted
2. Foreign material on segment ≤ 10 mil
3. Ink contamination (surface) ≤ 20 mils
4. Bubble in segment ≤ 10 mil
5. Bending $\leq 1\%$ of reflector length
6. Plastic pin's burr max is 0.1 mm

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3. Internal Circuit Diagram



4. Pin Connection

No	Connection
1	NO CONNECTION
2	CATHODE D
3	CATHODE E
4	COMMON ANODE
5	CATHODE C
6	CATHODE DP
7	CATHODE B
8	CATHODE A
9	COMMON ANODE
10	CATHODE F
11	NO CONNECTION
12	CATHODE G

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5. Rating and Characteristics

5.1. Absolute Maximum Rating at Ta=25°C

Parameter	Maximum Rating	Unit
Power Dissipation Per Segment	70	mW
Peak Forward Current Per Segment (1/10 Duty Cycle, 0.1ms Pulse Width)	60	mA
Continuous Forward Current Per Segment Derating Linear From 25°C Per Segment	25 0.28	mA mA/°C
Operating Temperature Range	-35°C to +105°C	
Storage Temperature Range	-35°C to +105°C	
Iron Soldering Conditions: 1/16 inch Below Seating Plane for 3 Seconds at 260°C		

5.2. Electrical / Optical Characteristics at Ta=25°C

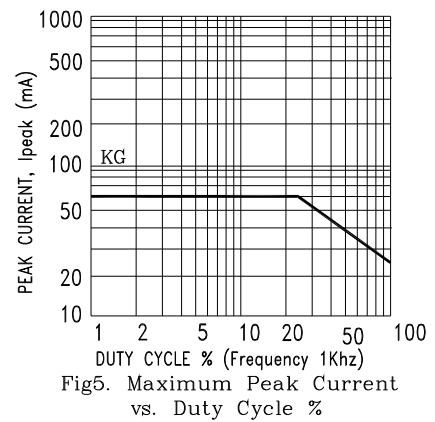
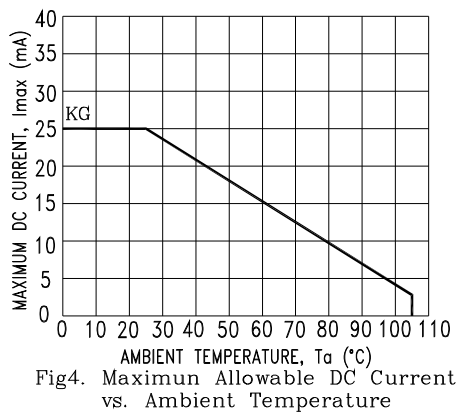
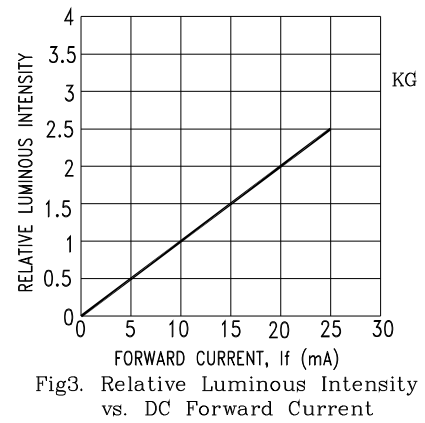
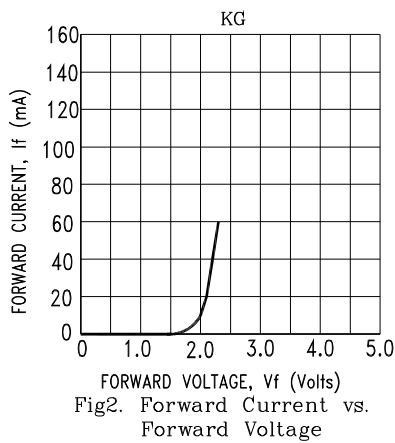
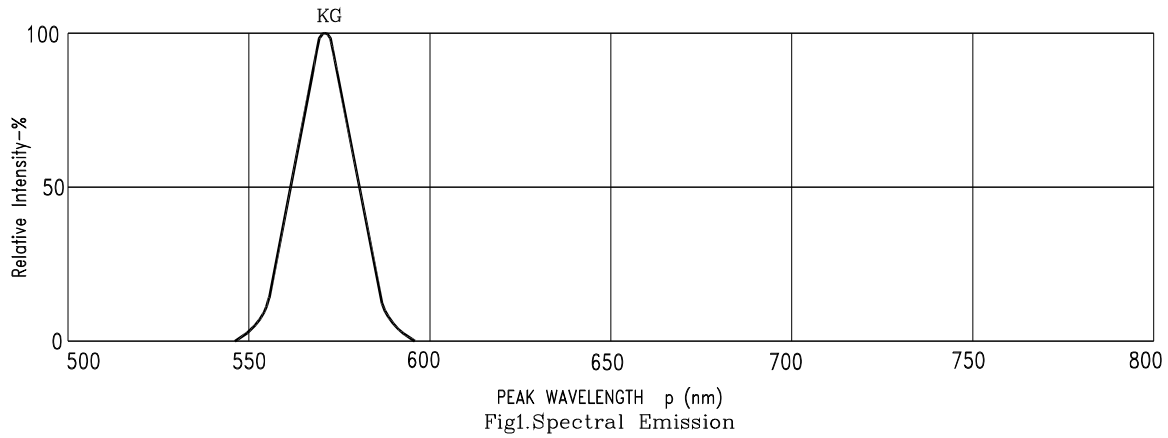
Parameter	Symbol	MIN.	TYP.	MAX.	Unit	Test Condition
Average Luminous Intensity Per Segment	IV	201	501		μcd	IF=2mA
			5210		μcd	IF=20mA
Peak Emission Wavelength	λp		574		nm	IF=20mA
Spectral Line Half-Width	Δλ		15		nm	IF=20mA
Dominant Wavelength	λd		571		nm	IF=20mA
Forward Voltage Per Chip	VF		2.05	2.6	V	IF=20mA
Reverse Current Per Segment ⁽²⁾	IR			100	μA	VR=5V
Luminous Intensity Matching Ratio (Similar Light Area)	IV-m			2:1		IF=2mA

Notes :

- Luminous intensity is measured with a light sensor and filter combination that approximates the CIE (Commission International De L'Eclairage) eye-response curve
- Reverse voltage is only for IR test. It cannot continue to operate at this situation
- Cross talk specification $\leq 2.5\%$

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5.3. Typical Electrical / Optical Characteristics Curves

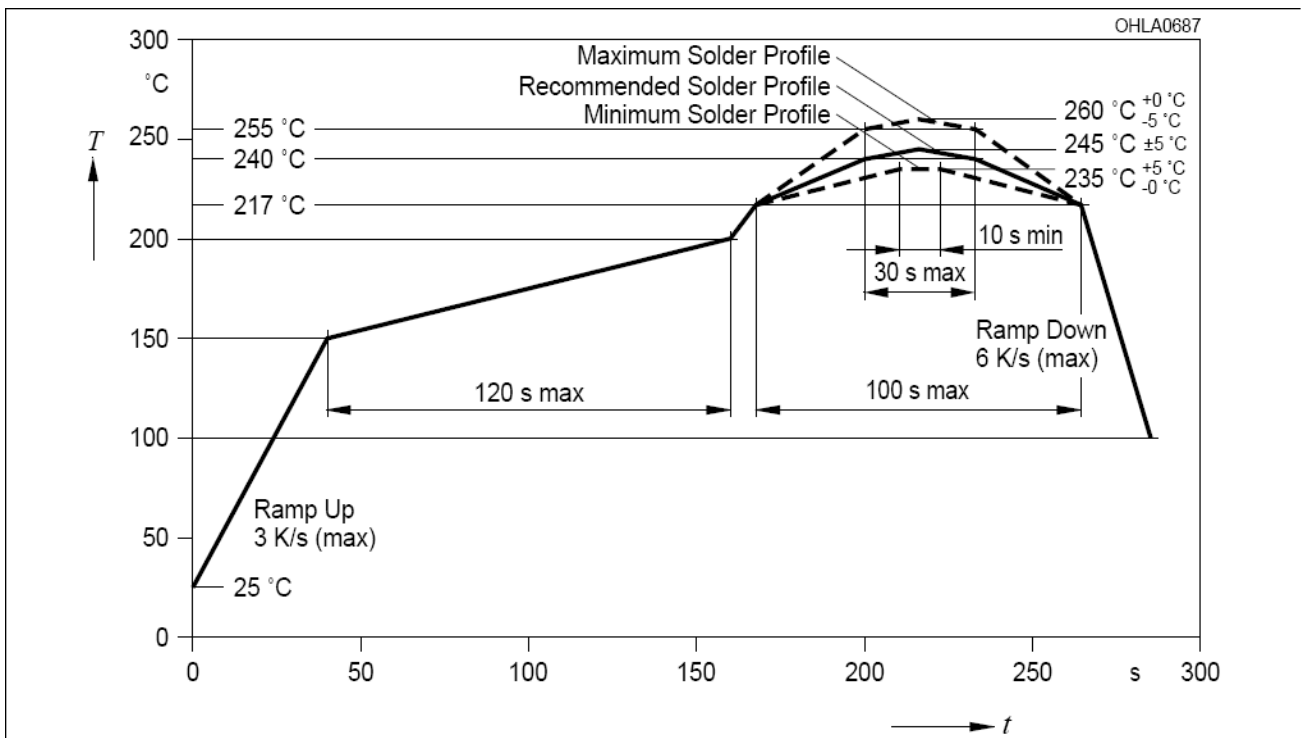


NOTE : KG=AlInGaP Green

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6. SMT SOLDERING INSTRUCTION

(Number of reflow process shall be less than 2 times, and cooling process to normal temperature is required between the first and the second soldering process)



Notes :

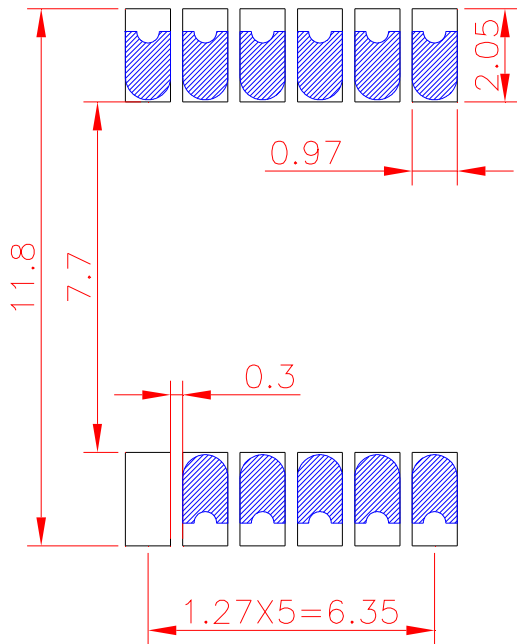
1. Recommended soldering condition

Reflow Soldering (Two times only)		Soldering Iron (One time only)	
Pre-heat:	120~150°C.	Temperature	300°C Max.
Pre-heat time:	120sec. Max.	Soldering time	3sec. Max.
Peak temperature:	260°C Max.		
Soldering time:	5sec. Max.		

2. Number of reflow process shall be less than 2 times, and cooling process to normal temperature is required between the first and the second soldering process.

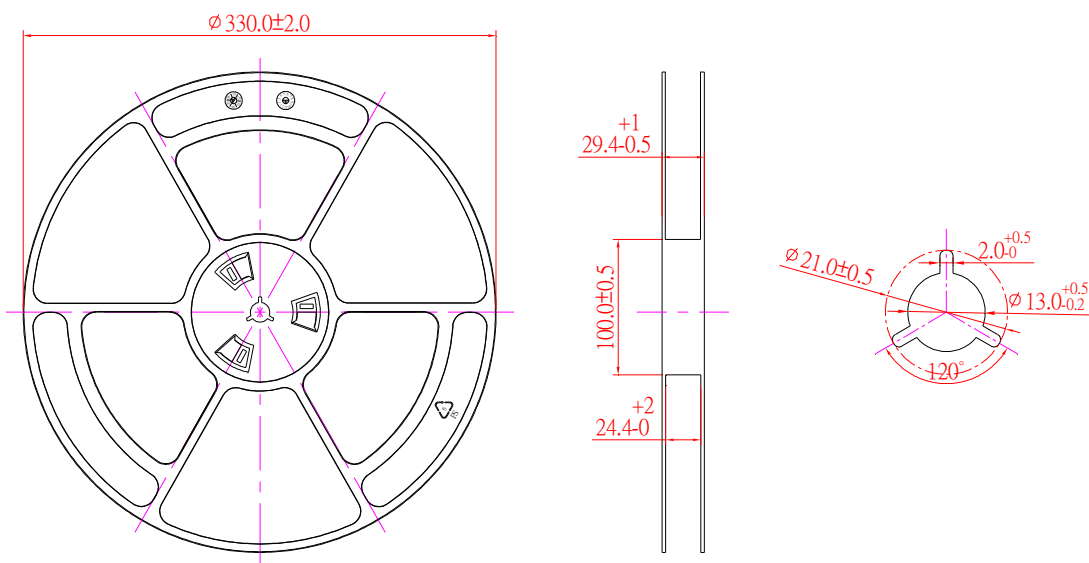
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7. Recommended Soldering Pattern



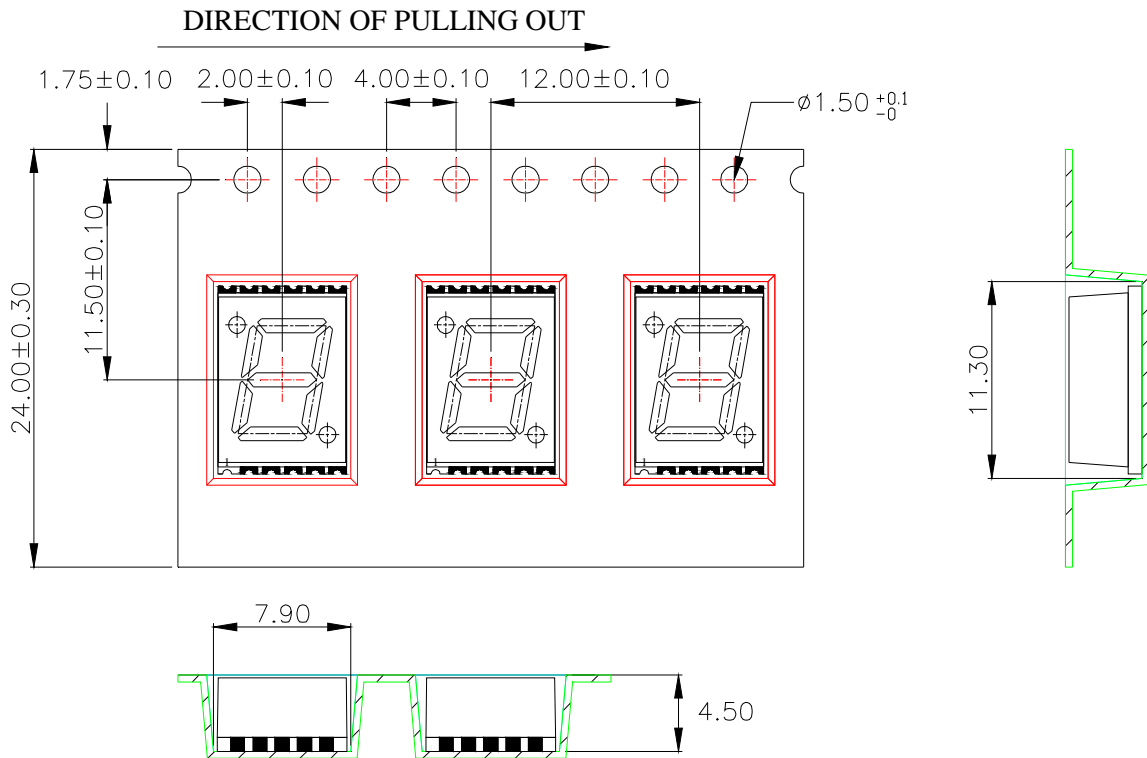
8. Packing Specification

8.1. Packing Reel Dimensions



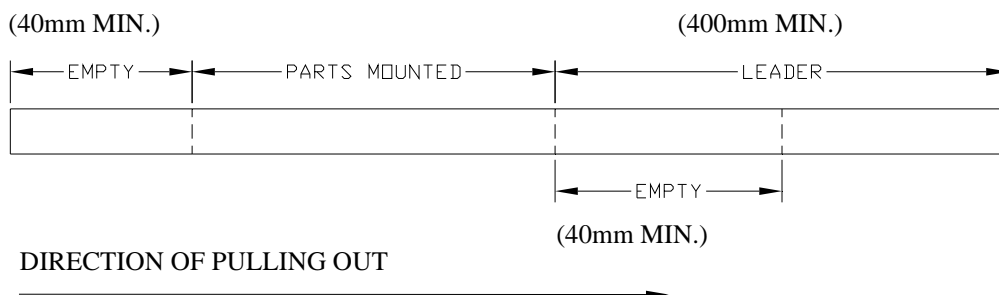
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8.2. Packing Carrier Dimensions



1. 10 sprocket hole pitch cumulative tolerance ± 0.20 .
2. Carrier camber is within 1 mm in 250 mm.
3. Material : Black Conductive Polystyrene Alloy.
4. All dimensions meet EIA-481 requirements.
5. Thickness : 0.40 ± 0.05 mm.
6. Packing length per 22" reel : 38.5 Meters.
7. Component load per 13" reel : 1000 pcs.
8. Minimum packing quantity is 250 pcs for remainders

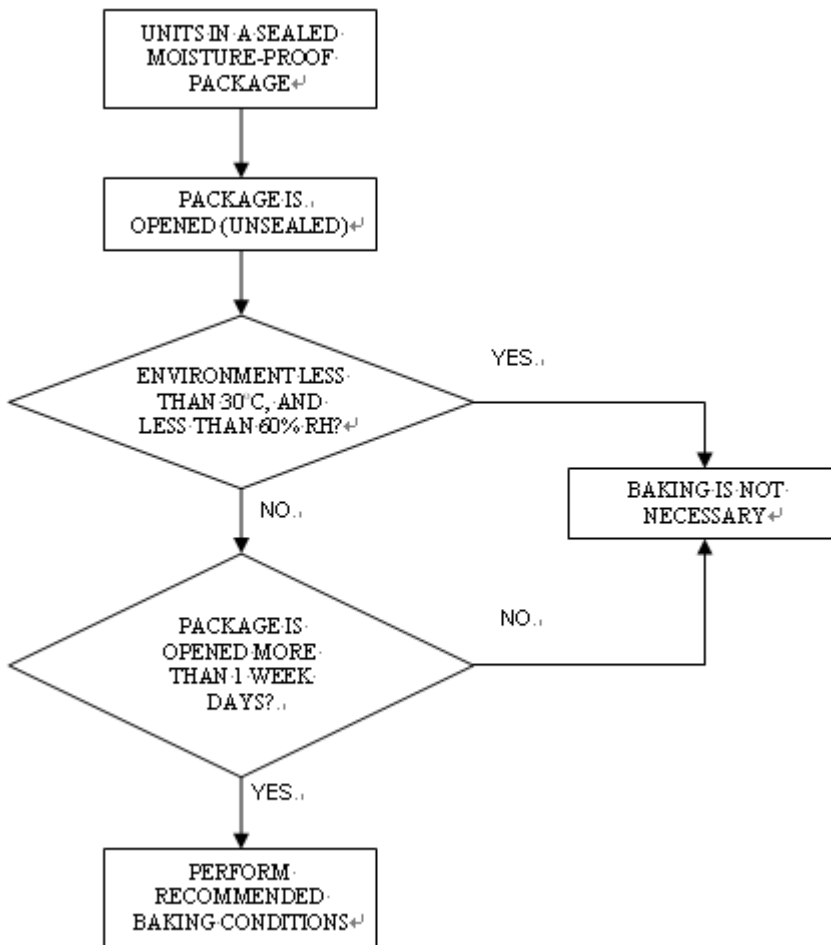
8.3. Trailer part / Leader part



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9. Moisture Proof Packing

All N/D SMD displays are shipped in moisture proof package. The displays should be stored at 30°C or less and 60% RH or less. Once the package opened, moisture absorption begins.



If the parts are not stored in dry conditions, they must be baked before reflow to prevent damage to the parts. Baking should only be done once

Package	Temperature	Time
In Reel	60°C	≥ 48hours
In Bulk	100°C	≥ 4hours
	125°C	≥ 2hours